

MG3503S LDMOS TRANSISTOR

Document Number: MG3503S
Product Datasheet V1.1

40W, 2.5-3.5GHz 28V RF LDMOS FETs

Description

The MG3503S is a 40-watt, internally matched, single ended LDMOS FETs, designed for multiple applications within full band 2.5-3.5GHz.

It can be used in Class AB/B and Class C for all typical modulation formats, for CW and pulsed, linear or saturated applications.

MG3503S



- Typical Performance (On Innogration 2.5-3.5GHz fixture with device soldered):

Voltage	Signal	Pin(dBm)	Pout(W)	Gain(dB)	Eff(%)
28	Pulse CW	37.5	49.5-54	9.5-9.9	38-52
28	CW	37.5	48-50	9-9.5	36-52
32	Pulse CW	37.5	60-66	10-10.8	36-52
32	CW	37.5	50-60	9.5-10.3	35-50

Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Excellent thermal stability, low HCI drift
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Pb-free, RoHS-compliant

Suitable Applications

- S band amplifier
- ISM applications
- Cellular amplifier

Table 1. Maximum Ratings

Rating	Symbol	Value	Unit
Drain--Source Voltage	V_{DS}	+65	Vdc
Gate--Source Voltage	V_{GS}	-10 to +10	Vdc
Operating Voltage	V_{DD}	+32	Vdc
Storage Temperature Range	T_{stg}	-65 to +150	°C
Case Operating Temperature	T_c	+150	°C
Operating Junction Temperature	T_j	+225	°C

Table 2. Thermal Characteristics

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case $T_c = 85^\circ\text{C}$, DC test	$R_{\theta JC}$	1.3	°C/W

Table 3. ESD Protection Characteristics

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

Table 4. Electrical Characteristics ($T_A = 25^\circ\text{C}$ unless otherwise noted)

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Characteristic	Symbol	Min	Typ	Max	Unit
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DC Characteristics

Zero Gate Voltage Drain Leakage Current ($V_{DS} = 65V$, $V_{GS} = 0V$)	I_{DSS}			100	μA
Zero Gate Voltage Drain Leakage Current ($V_{DS} = 28V$, $V_{GS} = 0V$)	I_{DSS}			1	μA
Gate--Source Leakage Current ($V_{GS} = 10V$, $V_{DS} = 0V$)	I_{GSS}			1	μA
Gate Threshold Voltage ($V_{DS} = 28V$, $I_D = 450\mu A$)	$V_{GS(th)}$		2.0		V
Gate Quiescent Voltage ($V_{DD} = 28V$, $I_D = 50mA$, Measured in Functional Test)	$V_{GS(Q)}$		2.4		V

Functional Tests (On Demo Test Fixture, 50 ohm system) $V_{DD} = 28Vdc$, $I_{DQ} = 50mA$, $f = 2500-3500MHz$, Pulse CW Signal .

Power Gain	G_p	9.5			dB
Drain Efficiency@P3dB	η_D		40		%
3 dB Compression Point	P_{-3dB}	40			W

Load Mismatch (In Innogration Test Fixture, 50 ohm system): $V_{DD} = 28Vdc$, $I_{DQ} = 50mA$, $f = 2500MHz$

VSWR 5:1 at 40W pulse CW Output Power	No Device Degradation
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2.5-3.5GHz

TYPICAL CHARACTERISTICS

Figure 2. Network analyzer output S11/S21 (VDS=28V IDQ=200mA VGS=2.95V)

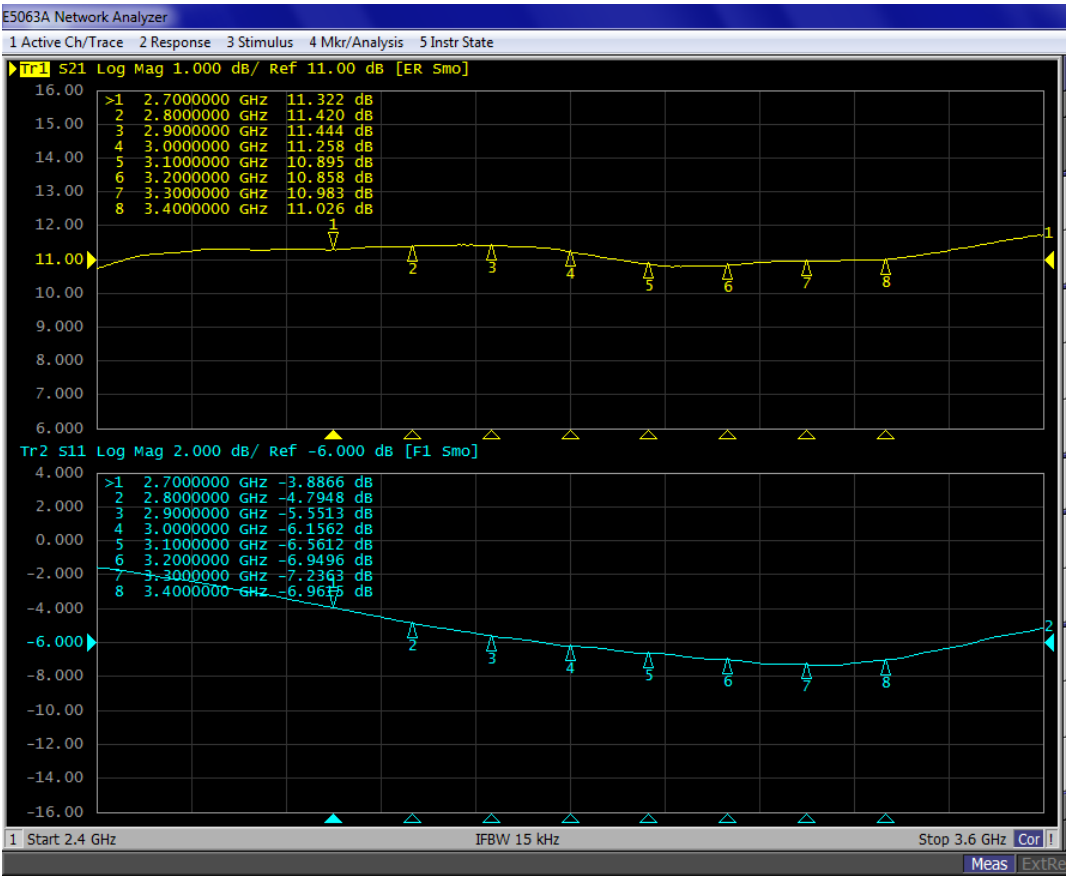
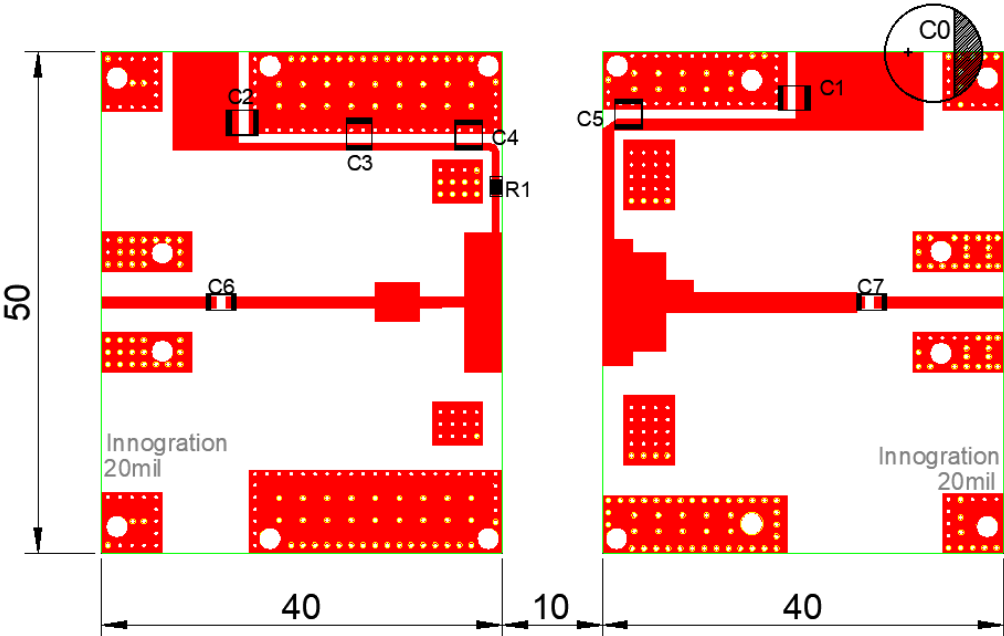


Figure 3. Test Circuit Component Layout



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Table 5. Test Circuit Component Designations and Values

Component	Description	Suggestion
C0	1000uF/63V	Electrolytic Capacitor
C1, C2	10uF	1210
C3, C4, C5, C6	10pF	MQ301111
R1	Chip Resistor,10Ω	0805
PCB	Rogers 4350B, thickness 20 mils, 1oz copper	

